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Structure of cation interstitial defects in nonstoichiometric rutile

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Résumé. — On présente ici de nouveaux modèles de défauts interstitiels pour accommoder la non-stoechiométrie du rutile peu réduit TiO_{2-x} . Ces défauts consistent en des arrangements linéaires, le long de directions [100] ou [010], de paires de cations trivalents situés au centre d'octaèdres d'oxygène ayant une face en commun. On décrit ensuite les mécanismes de diffusion permettant l'aggrégation de tels défauts pour donner naissance à des paires de plans de « cisaillement cristallographique », ainsi que cela a été récemment observé en microscopie électronique à haute résolution dans des cristaux TiO_{2-x} refroidis relativement lentement depuis la température de réduction de 1 050 °C. Des considérations relatives à l'énergie électrostatique expliquent pourquoi ces défauts ont une énergie de formation et de migration beaucoup plus basse que les défauts « ponctuels » traditionnels.

Abstract. — New cation interstitial defect models are derived for substoichiometric rutile TiO_{2-x} . These consist of linear arrangements, along [100] or [010], containing two face-shared octahedral pairs of trivalent cations. Diffusion mechanisms are described whereby these may readily aggregate to form pairs of crystallographic shear planes, as observed recently by high-resolution electron microscopy, when TiO_{2-x} specimens are cooled relatively slowly from 1 050 °C. Electrostatic arguments explain why these defects have very much lower formation and migration energies than the traditional « point defect » interstitial model.

1. Introduction. — Considerable uncertainty remains concerning the nature of the structural defects responsible for the phase TiO_{2-x} (see e.g. Akse and Whitehurst [1], for a recent literature survey). Most interpretations of physical property and resonance technique measurements have been based upon models for point defect equilibria (see e.g. Kofstad [2]).

Bursill and Hyde [3] questioned whether « classical » point defects occurred in reduced rutile since $\text{TiO}_{1.9986}$, well annealed at 1 000 °C and then slowly cooled, contained lamellae of crystallographic shear planes (CSP) coexisting with a maze of intersecting $\{ \bar{1}32 \} < 0\frac{1}{2}\frac{1}{2} >$ CSP. The latter was identified as the nonstoichiometric phase TiO_{2-x} . However, the interpretation of electrical conductivity measurements by Baumard, Panis and Anthony [4] and of quenching experiments followed by electron diffraction contrast studies (Blanchin, Faisant, Picard, Ezzo and Fontaine [5]) suggested that for $\text{TiO}_{1.9920-2.0000}$ the equilibrium phase existing at 1 050 °C

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contains no CSP. High-resolution electron microscope (HREM) studies of a number of TiO_{2-x} preparations ($0 < x < 0.0035$), reduced at 1 323 K and given a variety of thermomechanical histories, showed new phenomena (Blanchin, Bursill, Hutchison and Gai [6]; Bursill, Blanchin and Smith [7]; Smith, Blanchin and Bursill [8]). Thus CSP were *not* present, even *en miniature*, in non-deformed crystals quenched from 1 323 K, but did appear, frequently as very closely-spaced pairs, in more slowly cooled or reduced and deformed specimens. HREM revealed both lateral and longitudinal disorder within the structure of the CSP, the details of which were strongly dependent upon cooling histories. Many of the HREM images showed « spot » contrasts which suggest the presence of small ($< 20 \text{ \AA}$ diameter) defects. Recent electrical conductivity studies over a wider range of temperatures (T), and for relatively high partial pressures of oxygen ($p\text{O}_2$) (Marucco, Gautron and Lemasson [9], Gautron, Marucco and Lemasson [10]) suggest that there are three domains within the TiO_{2-x} phase, where the predominant defects are assumed to be :

- I *interstitial Ti_i^{4+}* , prevailing for $T > 900 \text{ }^\circ\text{C}$ and for relatively low partial pressures of oxygen ;
- II *doubly ionized oxygen vacancies V_O* , prevailing at lower temperatures and for increasing $p\text{O}_2$, and
- III *another oxygen vacancy defect*, initially interpreted as a single ionized oxygen V_O (Marucco *et al.* [9]) but later attributed to oxygen vacancies associated with charge compensation of aliovalent Me^{3+} impurities (Gautron *et al.* [10]) prevailing for $x < 0.00016$, independent of $p\text{O}_2$ or T .

In this letter we present new models for cation *interstitial defects* which were derived in an attempt to extend the structural principles of CS (previously identified to apply throughout most of the stoichiometry range $\text{TiO}_{1.5000}$ - $\text{TiO}_{2.0000}$) to account for the structure of interstitial defects in non-stoichiometric rutile. New structure models for anion vacancy and impurity defects will be presented elsewhere (Bursill and Blanchin, in preparation).

2. Derivation of interstitial structure. — 2.1 TRADITIONAL CATION INTERSTITIAL STRUCTURE. —

Figure 1a depicts the [010] bounded projection ($-\frac{1}{4} < y < \frac{1}{4}$) of the rutile structure, using the familiar octahedral representation. The $\frac{1}{4} < y < \frac{3}{4}$ bounded projection is symmetrically equivalent. (In earlier work it was convenient to take the corresponding [010] section, see Bursill

Fig. 1. — Bounded projection (along [100], for $-\frac{1}{4} \leq x \leq \frac{1}{4}$) of the structure of rutile, containing : a) no defect ; b) traditional interstitial defect, i.e. additional Ti^{3+} cations ; c) two pairs of octahedrally-coordinated Ti^{3+} cations sharing faces ; d), e) and f) show linear extensions of c) to produce more widely-separated pairs of face-shared octahedra.

and Hyde [3], the use of [010] in the present work proved surprisingly instructive.) Rutile is tetragonal with cell parameters $a = 4.5937 \text{ \AA}$, space group P_4/mnm with Ti at $000; \frac{1}{2}\frac{1}{2}\frac{1}{2}$ and O at $uu0; \frac{1}{2} - u, \frac{1}{2} + u, \frac{1}{2}$ and $\frac{1}{2} + u, \frac{1}{2} - u, \frac{1}{2}$ with $u = 0.3053$. Octahedrally coordinated interstitial sites may be found at $\frac{1}{2}00; \frac{1}{2}0\frac{1}{2}; 0\frac{1}{2}0; 0\frac{1}{2}\frac{1}{2}$ (see Hurlen [11]). Figure 1b depicts the classical model for the interstitial in rutile, whereby a Ti^{3+} cation is inserted at $(\frac{1}{2}00)$. Note the formation of a string of three face-shared octahedrally coordinated cation sites, separated by $2.3 \text{ \AA}$. Analysis of the electrostatic valencies (esv; see Megaw [12], for a discussion of this concept) of the oxygen ions (labelled O_1 and O_2 in Fig. 1b) associated with this model gives -2.00 for O_1 and -2.5 for O_2 . The latter implies a large electrostatic energy for such a defect. Bursill and Hyde [3] showed that the CSP observed by electron microscopy and diffraction techniques throughout most of the stoichiometry range $TiO_{1.5000-2.0000}$ all contain, as a common structural principle, pairs of face-shared octahedra linked by edge- and corner-sharing in such a way that they may be regarded as coherent intergrowths of *elements* of the corundum-like structure of e.g. Ti_2O_3 , with the rutile matrix. Our HREM observation that pairs of CSP occurred frequently in specimens relatively slowly-cooled across the TiO_{2-x} phase boundary suggest that the interstitial defects may consist of *two* pairs of face-shared octahedra and that these then aggregate in order to produce CSP. Thus figure 2a shows the octahedral arrangement in a [010] bounded projection through a pair of (121) CSP. Note that cations in face-shared octahedral sites must have (formally at least) charge $+3$ if the correct stoichiometry (Ti_2^{3+}, Ti_{n-2}^{4+}) O_{2n-1} is to be obtained for the CSP.

2.2 ALTERNATIVE CATION INTERSTITIAL DEFECT STRUCTURE. — Figure 1c shows that two pairs of face-shared octahedra may be readily obtained from figure 1b by shifting one of the cations (arrowed) by vector $[\frac{1}{2}00]$. Such a jump is formally equivalent to a cation Frenkel defect. However, this geometrical relationship is only superficial. In order to obtain a pair of CSP by aggregation of the defects shown in figure 1c, we require a Ti^{3+} cation in each of the face-shared sites. We therefore take as our basic interstitial defect figure 1c with four Ti^{3+} cations. Two of these occupy octahedral interstices and two substitute for Ti^{4+} cations in normal cation sites. In addition

Fig. 2. — Bounded projection (along [100], for $-\frac{1}{4} \leq x \leq \frac{1}{4}$) of the rutile structure containing : a) a pair of (121) crystallographic shear planes (CSP); b) a pair of (253) CSP; c) a pair of (132) CSP and d) a pair of (143) CSP.

one cation site, formerly occupied by Ti^{4+} , is now empty. Altogether we have replaced *three* normal Ti^{4+} cations by four Ti^{3+} cations, giving no net change in positive charge in the lattice, compared to the extra $+3$ charges in the classical model.

2.3 ENERGETIC CONSIDERATIONS. — This new defect model must have, at least in principle, very much lower electrostatic contributions, at both short and long-range, to both its formation and migration energies. Analysis of the electrostatic valencies of the oxygen sites show two crystallographically distinct sites (labelled O'_1 and O'_2 in Fig. 1c), with 12 O'_1 having $\text{esv} = -1.833$ and 6 O'_2 having $\text{esv} = -2.333$. The average esv is thus -2.0 , and we expect that ion relaxations and associated polarization of the oxygen ions (rutile has a high dielectric constant) will allow the esv of all of the oxygen ions to approach close to -2.0 . Simplistic electrostatic energy calculations, so far neglecting ion relaxations and polarization effects, using a difference-sum technique, showed that the new model is lower in electrostatic energy by ~ 100 eV, despite the fact that it contains four Ti^{3+} cations compared to one for the classical model (Bursill and Shen, in preparation). More extensive calculations are in progress but it is already very clear that the new model is an extremely efficient way, both energetically and chemically to incorporate Ti^{3+} cations into rutile.

3. Further consideration and discussion. — **3.1 MOBILITY AND AGGREGATION OF INTERSTITIAL DEFECTS.** — A pair of (121) CSP may be readily formed (Fig. 2a) by ordered aggregation of the defects shown in figure 1c, provided that the defects are reasonably mobile. Assuming a homogeneous distribution of such defects leads to the conclusion that CSP can form in the bulk of a reduced crystal and thus are not constrained to grow from the surface. Since the displacement vector across a pair of CSP is $\mathbf{R} = 0$ [Modulo 1] this may occur without necessarily creating a partial dislocation loop (of course, if dislocations already exist, as in deformed specimens, the defects may accrete to it and produce dissociation; we return to elaborate the various possibilities in another paper). Figures 3a, b, c indicate sequences of cooperative atomic diffusive jumps required for mobility parallel to $[001]$, $[100]$ and $[0\frac{1}{2}\frac{1}{2}]$ respectively. Note that we assume such defects are created at the crystal surfaces, following loss of oxygen to the gas phase on reduction of rutile. These jumps can always be carried out in such a way that triple-face-sharing of octahedra is avoided. Note that essentially Frenkel defects are involved but in addition we assume an accompanying electronic conductivity according to $\text{Ti}^{3+} \rightarrow \text{Ti}^{4+} + e^-$. This last

Fig. 3. — Arrows indicate suggested diffusion mechanisms for movement of Ti^{3+} interstitial defects parallel to a) $[001]$; b) $[100]$ and c) $[0\frac{1}{2}\frac{1}{2}]$. Dotted arrows indicate more complex concerted atom movements required for bulk diffusion of M^{3+} (e.g. Cr^{3+} or Fe^{3+}) interstitial defects.

process has a low activation energy (~ 0.40 eV, see Marucco *et al.* [9]). Similar diffusive hops allow CSP splitting, subsequent to their formation, to produce arbitrary separations (see Bursill *et al.* [13]).

3.2 LINEARLY EXTENDED INTERSTITIAL DEFECTS. — Our HREM observations showed that the local orientation of the CSP pairs observed in relatively slowly-cooled specimens fall between (121) and (143) with mean orientation (132). Figures 2b-d show the corresponding bounded projections through pairs of (253), (132) and (143) CSP respectively. This figure immediately suggests a further development of the cation interstitial model, depicted in figures 1d, e, f. Here successive $[\frac{1}{2}00]$ atomic jumps lead to further separation of the face-shared pairs, producing linear defects having extent starting at 9.2 Å and increasing to 13.8 Å, 18.4 Å or 27.2 Å respectively. Orderly aggregation of such defects leads naturally to pairs of higher index CSP. Furthermore, imperfect ordering of any one type, or of a mixture of different types leads naturally to lateral and longitudinal disorder within the CSP structure, as observed by HREM. It should be noted that the linear strings of displaced octahedra connecting the face-shared pairs in these linear defects occur as elements of the (011) antiphase boundary, or microtwin lamellar structures, often observed in rutile (see Blanchin *et al.* [6]; Bursill and Hyde [3]). The esv of the corresponding oxygens are -2.0 .

3.3 INTERSTITIAL DEFECTS IN DOPED SPECIMENS. — We note that CSP defects also occur in rutiles doped with Fe^{3+} or Cr^{3+} . The same interstitial defects models could apply here, with Ti^{3+} substituted by Me^{3+} , although as yet HREM has not been carried out to determine whether the CSP precipitate as pairs. (In such cases long-range diffusion mechanisms (dotted in Fig. 3), are required.) Thus the kinetic behaviour of doped specimens is expected to differ from that of the reduced binary system TiO_{2-x} .

3.4 LOCALIZATION OF ELECTRONS. — It has been convenient so far to assume that Ti^{3+} ions are (formally) attached to the face-shared octahedral sites. In fact electrical conductivity measurements suggest (Marucco *et al.* [9]) that at $T > 800^\circ\text{C}$, the effective charge of interstitial cations is Ti^{4+} , implying complete ionization of Ti^{3+} ions ($\text{Ti}^{3+} \rightarrow \text{Ti}^{4+} + e^-$, $I_3 = 0.40$ eV) with consequent delocalization of the electrons. Even at very low temperatures it is not certain that the Ti^{3+} ions will be located in face-shared octahedral sites. This appears to be the case for Ti_2O_3 , and we regard the shortest of the above linear defects as an element of Ti_2O_3 structure. However crystallographic studies of the phase transitions of Ti_4O_7 [14, 15] show that in that phase Ti^{3+} - Ti^{3+} pairing occurs between edge-shared octahedral sites, with only one of each face-shared octahedra containing a Ti^{3+} ion, for temperatures below 125 K. At room temperature and above all Ti ions have effective charge 3.5, indicating virtually complete delocalization of the electrons. Clearly the spatial extent of delocalization of electrons associated with small defects in TiO_{2-x} ($x \lesssim 0.0035$), and its temperature variation, remains an interesting problem, requiring further experimental and theoretical study.

4. Conclusion. — It is now necessary to seek further HREM evidence for the presence and interactions of cation interstitial defects described here. Computer simulations of HREM images (Bursill and Shen, in preparation) show that it should be possible to directly image, and positively identify, such small defects, and their aggregation, under very specific imaging conditions. *In situ* studies of the precipitation and dissolution of CSP, and complementary HREM studies, have already produced positive results and are in the course of publication [13].

In another paper the structure of oxygen vacancy defects in nonstoichiometric rutile is examined (Bursill and Blanchin, in preparation). It was again found possible to modify the classical model and derive a structure consistent with the common structural theme referred to above. Clearly

the principles of point defect equilibria used for the analysis of a wide range of physical property measurements (electrical conductivity, thermogravimetry, ionic conductivities, internal friction, electron-spin-resonance, etc...) will need to be carefully reassessed in the light of such models.

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